Taiwan Semiconductor

2A, 50V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Glass passivated chip junction
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.090g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	2	А		
V _{RRM}	50 - 1000	V		
I _{FSM}	50	А		
T _{J MAX}	150	°C		
Package	DO-214AA (SMB)			
Configuration	Single die			



HALOGEN

DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)									
PARAMETER	SYMBOL	RS 2ah	RS 2BH	RS 2DH	RS 2GH	RS 2JH	RS 2KH	RS 2MH	UNIT
Marking code on the device		RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	RS2M	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	I _F				2				Α
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50			A				
Junction temperature	TJ	T _J - 55 to +150			°C				
Storage temperature	T _{STG}			- {	55 to +1	50			°C



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THERMAL PERFORMANCE

PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-ambient thermal resistance	R _{eja}	55	°C/W
Junction-to-lead thermal resistance	R _{eJL}	18	°C/W

ELECTRICAL SPECIFICATIONS (TA = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾		$I_F = 2A, T_J = 25^{\circ}C$	V _F	-	1.3	V
Boweres surrent @ roted V ⁽²⁾		T _J = 25°C		-	5	μA
Reverse current @ rated $V_R^{(2)}$		T _J = 125°C	I _R	-	50	μA
Junction capacitance		$1MHz, V_R = 4.0V$	CJ	50	-	pF
Reverse recovery time	RS2AH	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t _{rr}	-	150	ns
	RS2BH					ns
	RS2DH					ns
	RS2GH					ns
	RS2JH			-	250	ns
	RS2KH			-	500	ns
	RS2MH					ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
RS2xH	DO-214AA (SMB)	3,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 50V(RS2AH) to 1000V(RS2MH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

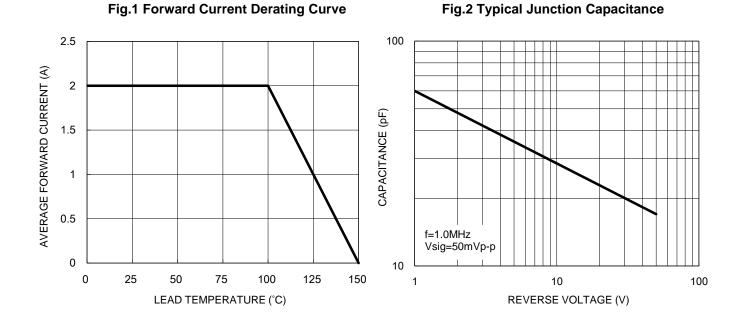


Fig.3 Typical Reverse Characteristics

T_=125°C

T_=25[°]C

80

100

10

1

0.1

20

30

40

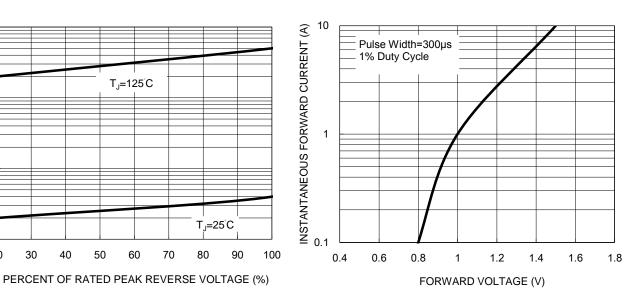
50

60

70

INSTANTANEOUS REVERSE CURRENT (µA)

Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

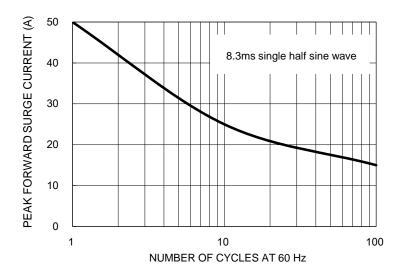
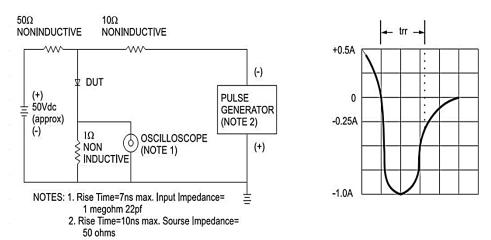


Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram



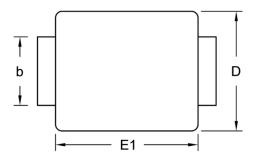
Version: A2102

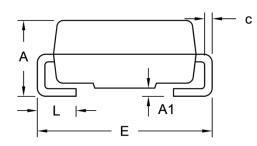
RS2AH – RS2MH Taiwan Semiconductor



PACKAGE OUTLINE DIMENSIONS

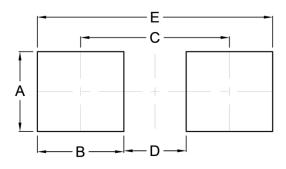
DO-214AA (SMB)





DIM.	Unit (mm)		Unit	(inch)
	Min.	Max.	Min.	Max.
A	1.95	2.65	0.077	0.104
A1	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
с	0.15	0.31	0.006	0.012
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.60	0.030	0.063

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound

YW = Date Code

F = Factory Code



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